

APPENDIX

Changes to Claims:

The following is a marked-up version of the amended claim:

14. (Three Times Amended) A flexible wiring board comprising a plurality of patterned metal films with a resin film being interposed therebetween, among which at least adjacent two patterned metal films are electrically connected to each other via bumps, one of said patterned metal film having at least one opening, wherein said resin film includes a solvent and the resin film is thermally shrinkable to press said bumps against said at least adjacent two patterned metal films to discharge moisture by discharging the solvent through at least one opening of said patterned metal film when heat is applied to the flexible wiring board.